

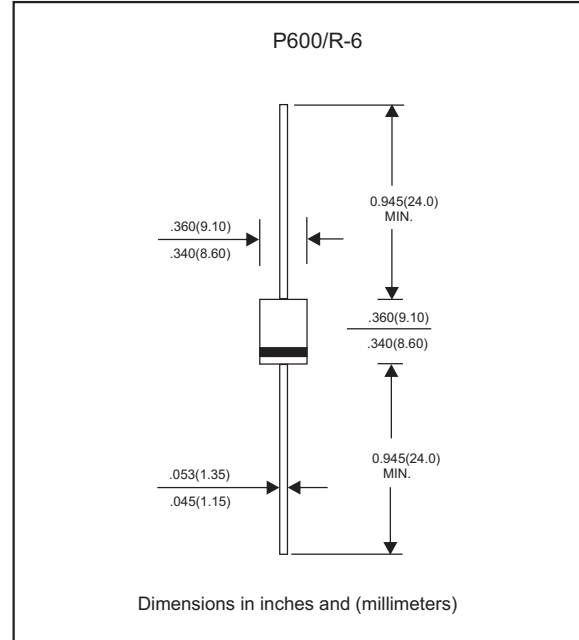
Features

- Axial lead type devices for through hole design.
- High current capability.
- High surge capability.
- Glass passivated chip junction.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228
- Suffix "-H" indicates Halogen-free parts

Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : Molded plastic, P600/R-6
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guranteed
- Polarity: Color band denotes cathode end
- Mounting Position : Any

Package outline



Maximum ratings and Electrical Characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	I_o			6.0	A
Forward surge current	8.3ms single half sine-wave (JEDEC methode)	I_{FSM}			200	A
Reverse current	$V_R = V_{RRM} T_J = 25^\circ\text{C}$	I_R			10	μA
	$V_R = V_{RRM} T_J = 100^\circ\text{C}$				500	
Thermal resistance	Junction to ambient	$R_{\theta JA}$		40		$^\circ\text{C}/\text{W}$
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C_J		100		pF
Storage temperature		T_{STG}	-65		+175	$^\circ\text{C}$

SYMBOLS	V_{RRM}^{*1} (V)	V_{RMS}^{*2} (V)	V_R^{*3} (V)	V_F^{*4} (V)	Operating temperature $T_J, (^\circ\text{C})$
6A05G	50	35	50	1.00	-55 to +150
6A1G	100	70	100		
6A2G	200	140	200		
6A4G	400	280	400		
6A6G	600	420	600		
6A8G	800	560	800		
6A10G	1000	700	1000		

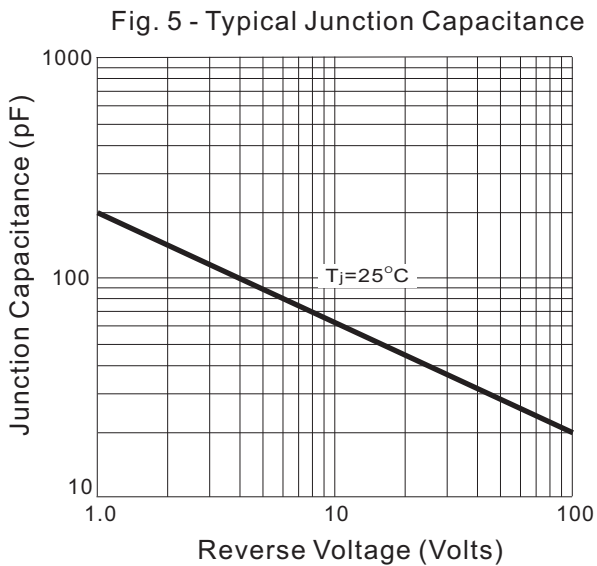
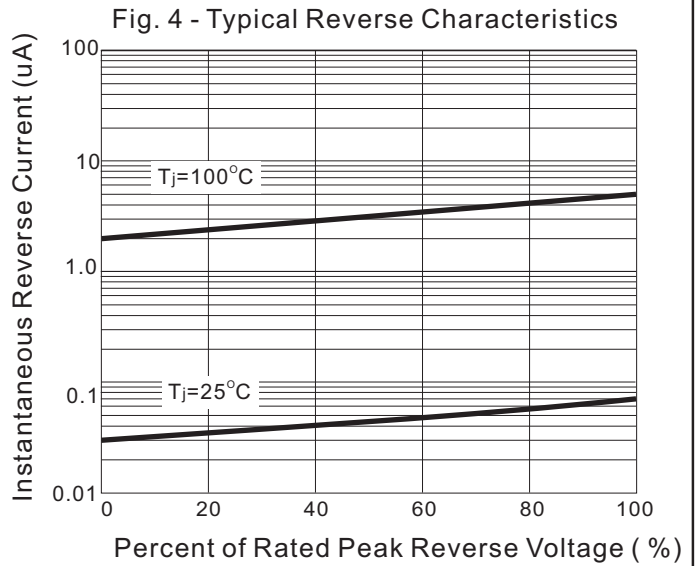
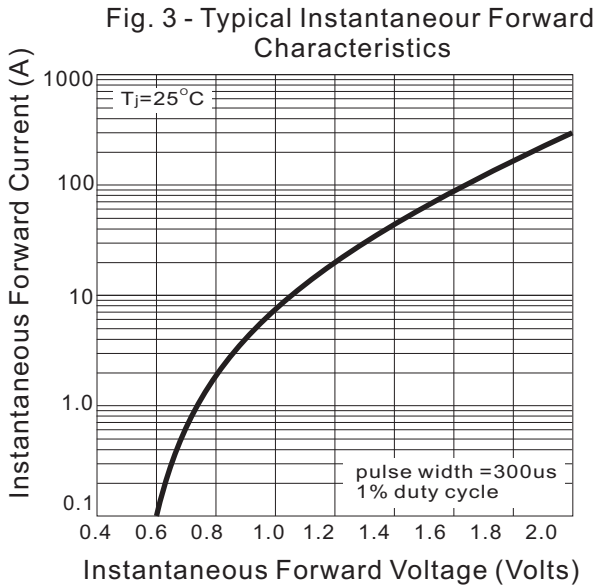
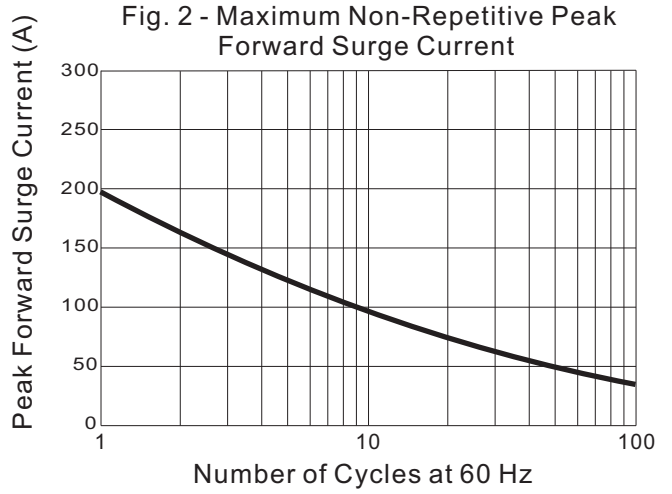
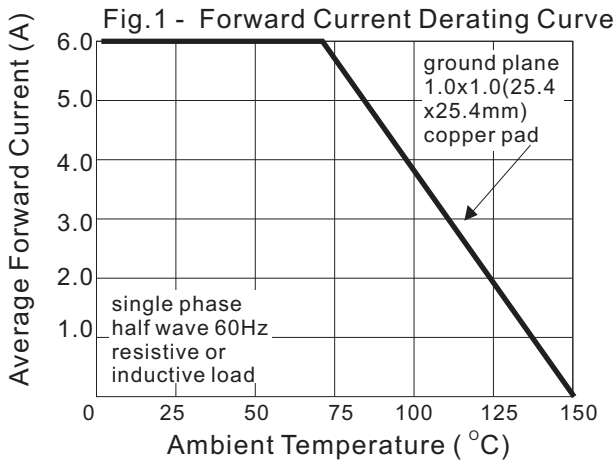
*1 Repetitive peak reverse voltage

*2 RMS voltage



*3 Continuous reverse voltage

*4 Maximum forward voltage@ $I_F=6.0\text{A}$

Rating and characteristic curves (6A05G THRU 6A10G)



Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

Marking

Type number	Marking code
6A05G	6A05G
6A1G	6A1G
6A2G	6A2G
6A4G	6A4G
6A6G	6A6G
6A8G	6A8G
6A10G	6A10G